

**TRANSMITTAL**

Electronic Version v1.1

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<b>Title of Invention</b>	<b>SNAP-IN HEAT SINK FOR SEMICONDUCTOR MOUNTING</b>	
Application Number: 10/604252 Date: 2003-07-06 First Named Applicant: Mr. Dennis R. Sigl  Confirmation Number: 1251 Attorney Docket Number: ITW7510.070		
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